

STP16NF06 STP16NF06FP

N-channel 60V - 0.08Ω - 16A - TO-220/TO-220FP STripFET™ II Power MOSFET

General features

| Туре | V _{DSS} | R _{DS(on)} | ۱ _D |
|-------------|------------------|---------------------|----------------|
| STP16NF06 | 60V | <0.1Ω | 16A |
| STP16NF06FP | 60V | <0.1Ω | 11A |

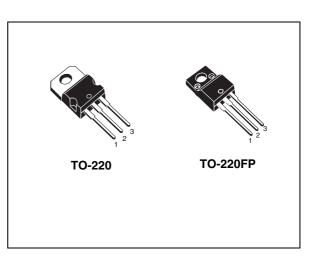
- Exceptional dv/dt capability
- Low gate charge at 100°C
- Application oriented characterization

Description

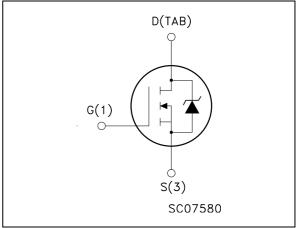
This Power MOSFET is the latest development of STMicroelectronics unique "Single Feature Size™" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

Applications

Switching application



Internal schematic diagram



Order codes

| Part number | Marking | Package | Packaging |
|-------------|---------|----------|-----------|
| STP16NF06 | P16NF06 | TO-220 | Tube |
| STP16NF06FP | P16NF06 | TO-220FP | Tube |

Contents

| 1 | Electrical ratings |
|---|---|
| 2 | Electrical characteristics |
| | 2.1 Electrical characteristics (curves) |
| 3 | Test circuit |
| 4 | Package mechanical data 10 |
| 5 | Revision history13 |



1 Electrical ratings

| Symbol | Parameter | Va | lue | Unit |
|--------------------------------|---|----------------------|--------------------|------|
| | | TO-220 | TO-220FP | |
| V_{DS} | Drain-source voltage ($V_{GS} = 0$) | 6 | 0 | V |
| V _{GS} | Gate- source voltage | ± | 20 | V |
| ۱ _D | Drain current (continuous) at $T_C = 25^{\circ}C$ | 16 | 11 ⁽¹⁾ | А |
| ۱ _D | Drain current (continuous) at $T_C = 100^{\circ}C$ | 11 | 7.5 ⁽¹⁾ | А |
| I _{DM} ⁽²⁾ | Drain current (pulsed) | 64 | 44 ⁽¹⁾ | А |
| P _{tot} | Total dissipation at $T_{C} = 25^{\circ}C$ | 45 | 25 | W |
| | Derating factor | 0.3 | 0.17 | W/°C |
| dv/dt ⁽³⁾ | Peak diode recovery voltage slope | 20 | | V/ns |
| E _{AS} ⁽⁴⁾ | Single pulse avalanche energy | 1: | 30 | mJ |
| I _{AR} | Avalanche current, repetitive or not- repetitive | 16 | | А |
| V _{ISO} | Insulation withstand voltage (DC) | nd voltage (DC) 2500 | | |
| T _{stg} | Storage temperature | | | ŝ |
| Тj | Max. operating junction temperature | 55 to 175 °C | | |

| Table 1. | Absolute | maximum | ratings |
|----------|-----------|----------|---------|
| | / Soorato | maximani | raingo |

1. Current limited by package's thermal resistance

2. Pulse width limited by safe operating area.

3. $I_{SD} \leq 16A$, di/dt $\leq 200A/\mu s$, $V_{DD} \leq V_{(BR)DSS}$, $Tj \leq T_{JMAX}$

4. Starting T_j = 25 °C, I_D = 8A, V_{DD} = 30V

Table 2.Thermal data

| | | TO-220 TO-220FP | | | | | |
|-----------|--|-----------------|--|--|--|--|--|
| Rthj-case | Thermal resistance junction-case max | 3.33 6 °C | | | | | |
| Rthj-amb | Thermal resistance junction-ambient max | 62.5 °C/V | | | | | |
| TJ | Maximum lead temperature for soldering purpose | 300 °(| | | | | |



2 Electrical characteristics

(T_{CASE}=25°C unless otherwise specified)

| | 0.40.00 | | | | | |
|----------------------|--|--|------|------|---------|----------|
| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
| V _{(BR)DSS} | Drain-source breakdown voltage | I _D = 250μΑ, V _{GS} =0 | 60 | | | V |
| I _{DSS} | Zero gate voltage drain current (V _{GS} = 0) | V_{DS} = max ratings V_{DS} = max ratings, T_{C} = 125°C | | | 1 10 | μΑ μΑ |
| I _{GSS} | Gate-body leakage current (V _{DS} = 0) | $V_{GS} = \pm 20V$ | | | ±100 | nA |
| V _{GS(th)} | Gate threshold voltage | $V_{DS} = V_{GS}, I_D = 250 \mu A$ | 2 | | 4 | V |
| R _{DS(on)} | Static drain-source on resistance | $V_{GS} = 10V, I_D = 8A$ | | 0.08 | 0.1 | Ω |

Table 3. On/off states

Table 4.Dynamic

| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|---|--|---|------|--------------------|------|----------------------|
| 9 _{fs} ⁽¹⁾ | Forward transconductance | V _{DS} = 15V, I _D = 8A | | 6.5 | | S |
| C _{iss} C _{oss} C _{rss} | Input capacitance Output capacitance Reverse transfer capacitance | V _{DS} = 25V, f = 1MHz, V _{GS} = 0 | | 315 70 30 | | pF pF pF |
| t _{d(on)} t _r t _{d(off)} t _f | Turn-on delay time Rise time Turn-off delay time Fall time | $V_{DD} = 30V, I_D = 8A$ $R_G = 4.7\Omega V_{GS} = 10V$ (see <i>Figure 15</i>) | | 7 18 17 6 | | ns ns ns ns |
| Q _g Q _{gs} Q _{gd} | Total gate charge Gate-source charge Gate-drain charge | $V_{DD} = 48V, I_D = 16A,$ $V_{GS} = 10V$ (see <i>Figure 16</i>) | | 10 3.5 3.5 | 13 | nC nC nC |

1. Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%.



| Symbol | Parameter | Test conditions | Min. | Тур. | Max. | Unit |
|--|--|--|------|-----------------|----------|---------------|
| I _{SD} I _{SDM} ⁽¹⁾ | Source-drain current Source-drain current (pulsed) | | | | 16 64 | A A |
| V _{SD} ⁽²⁾ | Forward on voltage | I _{SD} = 16A, V _{GS} = 0 | | | 1.3 | V |
| t _{rr} Q _{rr} I _{RRM} | Reverse recovery time Reverse recovery charge Reverse recovery current | I _{SD} = 15A, di/dt = 100A/μs, V _{DD} = 30V, T _j = 150°C (see <i>Figure 17</i>) | | 50 88 3.5 | | ns nC A |

Table 5.Source drain diode

1. Pulse width limited by safe operating area.

2. Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%



 $Z_{th} = k R_{thJ-c}$ $\delta = t_{\rm p}/\tau$

10⁰ t_P(s)

Thermal impedance for TO-220

0.05

.02 0 0.01

Electrical characteristics (curves) 2.1

Figure 1. Safe operating area for TO-220

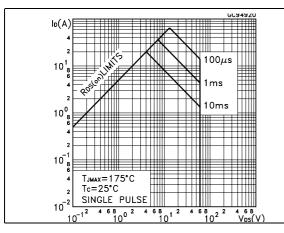
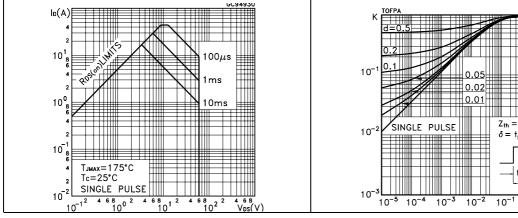
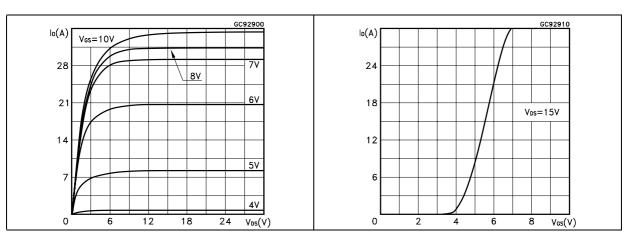


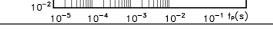
Figure 3. Safe operating area for TO-220FP











PULSE

INGLE

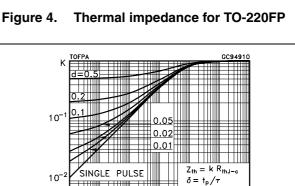


Figure 2.

280TOA

d=0

κ

10



Figure 7. Transconductance

Figure 8. Static drain-source on resistance

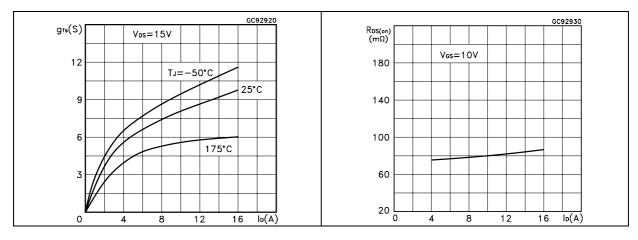
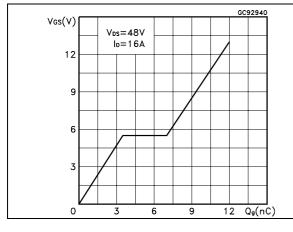


Figure 9. Gate charge vs. gate-source voltage Figure 10. Capacitance variations



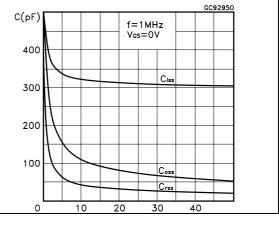


Figure 11. Normalized gate threshold voltage Fig vs. temperature

Figure 12. Normalized on resistance vs. temperature

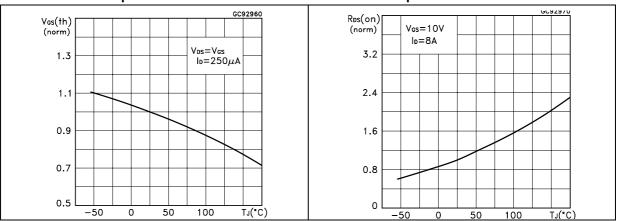
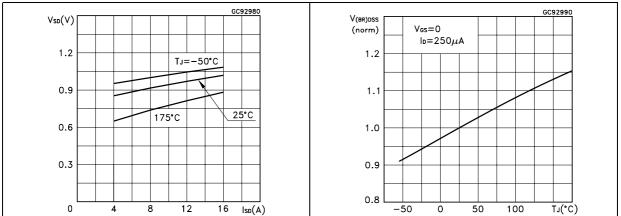


Figure 13. Source-drain diode forward characteristics

Figure 14. Normalized B_{VDSS} vs. temperature





3 Test circuit

Figure 15. Switching times test circuit for resistive load

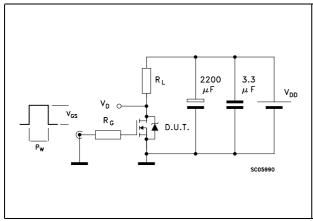
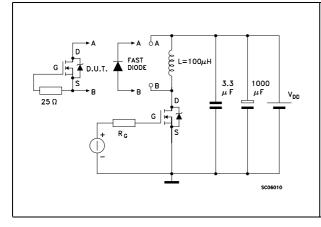


Figure 17. Test circuit for inductive load switching and diode recovery times





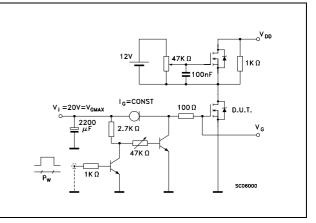


Figure 18. Unclamped Inductive load test circuit

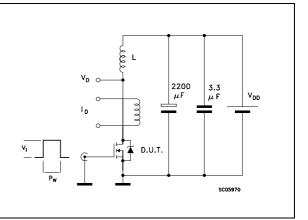
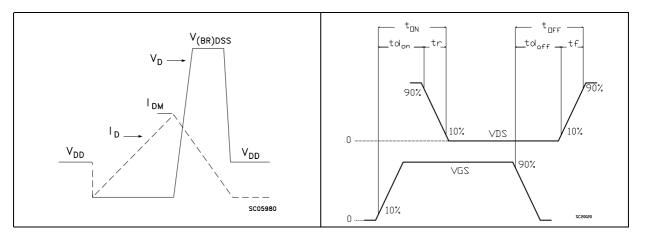


Figure 20. Switching time waveform



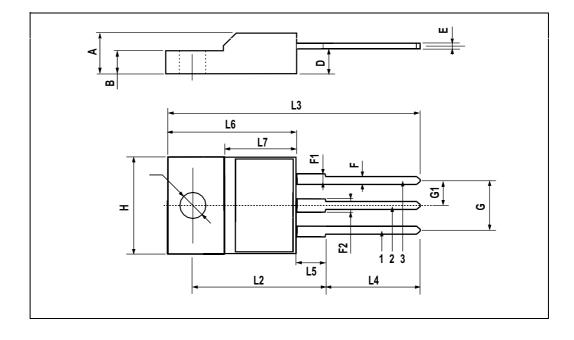
57

4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com



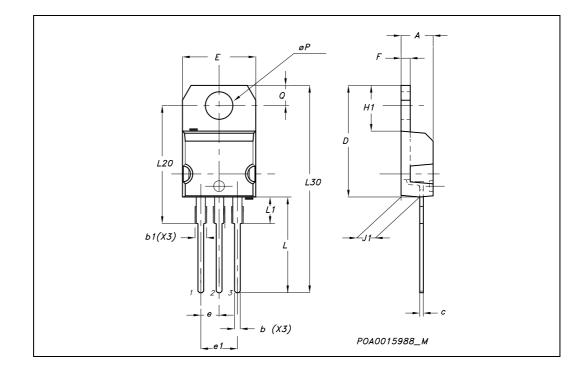
| TO-220FP MECHANICAL DATA | | | | | | |
|--------------------------|------|-----|------|-------|-------|-------|
| DIM | | mm. | | | inch | |
| DIM. | MIN. | ТҮР | MAX. | MIN. | TYP. | MAX. |
| А | 4.4 | | 4.6 | 0.173 | | 0.181 |
| В | 2.5 | | 2.7 | 0.098 | | 0.106 |
| D | 2.5 | | 2.75 | 0.098 | | 0.108 |
| Е | 0.45 | | 0.7 | 0.017 | | 0.027 |
| F | 0.75 | | 1 | 0.030 | | 0.039 |
| F1 | 1.15 | | 1.7 | 0.045 | | 0.067 |
| F2 | 1.15 | | 1.7 | 0.045 | | 0.067 |
| G | 4.95 | | 5.2 | 0.195 | | 0.204 |
| G1 | 2.4 | | 2.7 | 0.094 | | 0.106 |
| Н | 10 | | 10.4 | 0.393 | | 0.409 |
| L2 | | 16 | | | 0.630 | |
| L3 | 28.6 | | 30.6 | 1.126 | | 1.204 |
| L4 | 9.8 | | 10.6 | .0385 | | 0.417 |
| L5 | 2.9 | | 3.6 | 0.114 | | 0.141 |
| L6 | 15.9 | | 16.4 | 0.626 | | 0.645 |
| L7 | 9 | | 9.3 | 0.354 | | 0.366 |
| Ø | 3 | | 3.2 | 0.118 | | 0.126 |





57

| TO-220 MECHANICAL DATA | | | | | | |
|------------------------|-------|-------|-------|-------|-------|-------|
| DIM. | | mm. | | | inch | |
| | MIN. | ТҮР | MAX. | MIN. | TYP. | MAX |
| А | 4.40 | | 4.60 | 0.173 | | 0.181 |
| b | 0.61 | | 0.88 | 0.024 | | 0.034 |
| b1 | 1.15 | | 1.70 | 0.045 | | 0.066 |
| С | 0.49 | | 0.70 | 0.019 | | 0.027 |
| D | 15.25 | | 15.75 | 0.60 | | 0.620 |
| E | 10 | | 10.40 | 0.393 | | 0.409 |
| е | 2.40 | | 2.70 | 0.094 | | 0.106 |
| e1 | 4.95 | | 5.15 | 0.194 | | 0.202 |
| F | 1.23 | | 1.32 | 0.048 | | 0.052 |
| H1 | 6.20 | | 6.60 | 0.244 | | 0.256 |
| J1 | 2.40 | | 2.72 | 0.094 | | 0.107 |
| L | 13 | | 14 | 0.511 | | 0.551 |
| L1 | 3.50 | | 3.93 | 0.137 | | 0.154 |
| L20 | | 16.40 | | | 0.645 | |
| L30 | | 28.90 | | | 1.137 | |
| øР | 3.75 | | 3.85 | 0.147 | | 0.151 |
| Q | 2.65 | | 2.95 | 0.104 | | 0.116 |



TO-220 MECHANICAL DATA

5 Revision history

Table 6. Revision history

| Date | Revision | Changes |
|-------------|----------|---------------------------------|
| 09-Sep-2004 | 4 | Preliminary version |
| 28-Jun-2005 | 5 | Complete version |
| 21-Jul-2005 | 6 | ECOPACK label inserted |
| 09-Aug-2006 | 7 | New template, no content change |
| 20-Feb-2007 | 8 | Typo mistake on page 1 |



Please Read Carefully:

Information in this document is provided solely in connection with ST products. STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, modifications or improvements, to this document, and the products and services described herein at any time, without notice.

All ST products are sold pursuant to ST's terms and conditions of sale.

Purchasers are solely responsible for the choice, selection and use of the ST products and services described herein, and ST assumes no liability whatsoever relating to the choice, selection or use of the ST products and services described herein.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted under this document. If any part of this document refers to any third party products or services it shall not be deemed a license grant by ST for the use of such third party products or services, or any intellectual property contained therein or considered as a warranty covering the use in any manner whatsoever of such third party products or services or any intellectual property contained therein.

UNLESS OTHERWISE SET FORTH IN ST'S TERMS AND CONDITIONS OF SALE ST DISCLAIMS ANY EXPRESS OR IMPLIED WARRANTY WITH RESPECT TO THE USE AND/OR SALE OF ST PRODUCTS INCLUDING WITHOUT LIMITATION IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION), OR INFRINGEMENT OF ANY PATENT, COPYRIGHT OR OTHER INTELLECTUAL PROPERTY RIGHT.

UNLESS EXPRESSLY APPROVED IN WRITING BY AN AUTHORIZED ST REPRESENTATIVE, ST PRODUCTS ARE NOT RECOMMENDED, AUTHORIZED OR WARRANTED FOR USE IN MILITARY, AIR CRAFT, SPACE, LIFE SAVING, OR LIFE SUSTAINING APPLICATIONS, NOR IN PRODUCTS OR SYSTEMS WHERE FAILURE OR MALFUNCTION MAY RESULT IN PERSONAL INJURY, DEATH, OR SEVERE PROPERTY OR ENVIRONMENTAL DAMAGE. ST PRODUCTS WHICH ARE NOT SPECIFIED AS "AUTOMOTIVE GRADE" MAY ONLY BE USED IN AUTOMOTIVE APPLICATIONS AT USER'S OWN RISK.

Resale of ST products with provisions different from the statements and/or technical features set forth in this document shall immediately void any warranty granted by ST for the ST product or service described herein and shall not create or extend in any manner whatsoever, any liability of ST.

ST and the ST logo are trademarks or registered trademarks of ST in various countries.

Information in this document supersedes and replaces all information previously supplied.

The ST logo is a registered trademark of STMicroelectronics. All other names are the property of their respective owners.

© 2007 STMicroelectronics - All rights reserved

STMicroelectronics group of companies

Australia - Belgium - Brazil - Canada - China - Czech Republic - Finland - France - Germany - Hong Kong - India - Israel - Italy - Japan -Malaysia - Malta - Morocco - Singapore - Spain - Sweden - Switzerland - United Kingdom - United States of America

www.st.com

